

Heat Sink Paste | 25 g | Tube

General information

Heat sink compound suitable for PCBs in transistors, for diodes, CPUs etc.

Use it between -50 °C and 180 °C

25 g compound tube type.

Specifications

Packaging: Polybag

Content: 1 pc



Sales information

Order code: **HSPA25T**
Product description: Heat Sink Paste | 25 g | Tube
Packaging: Polybag
Brand name: Nedis



Quantity	LxWxH (mm)	Weight
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1	30x15x90	40 gr.
10	95x35x135	300 gr.
330	340x150x450	10340 gr.
660	360x345x480	21700 gr.